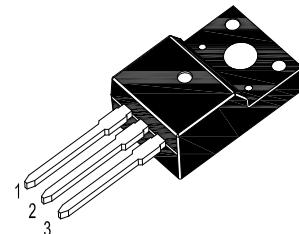
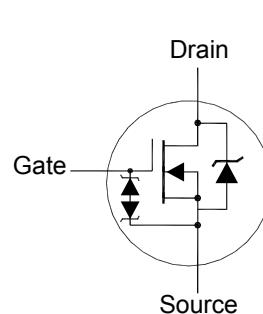


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N-Channel Enhancement Mode Power MOSFET



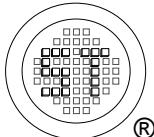
TO-220F Plastic Package
1.Gate 2.Drain 3.Source

Absolute Maximum Ratings

| Parameter | Symbol | Value | Unit |
|--|----------------|---------------|------|
| Drain-Source Voltage | V_{DS} | 800 | V |
| Gate-Source Voltage | V_{GS} | ± 30 | V |
| Drain Current $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$ | I_D | 19.5 12.3 | A |
| Peak Drain Current | I_{DM} | 78 | A |
| Power Dissipation $T_C = 25^\circ\text{C}$ | P_{tot} | 40 | W |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | - 55 to + 150 | °C |

Thermal Characteristics

| Parameter | Symbol | Max. | Unit |
|---|-----------------|------|------|
| Maximum Thermal Resistance from Junction to Case | $R_{\theta JC}$ | 3.1 | °C/W |
| Maximum Thermal Resistance from Junction to Ambient | $R_{\theta JA}$ | 62.5 | °C/W |



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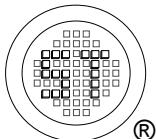


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Characteristics at $T_C = 25^\circ\text{C}$ unless otherwise specified

| Parameter | Symbol | Min. | Typ. | Max. | Unit |
|---|---------------------|--------|--------|----------|---------------|
| Drain-Source Breakdown Voltage at $I_D = 1 \text{ mA}$ | BV_{DSS} | 800 | - | - | V |
| Drain-Source Leakage Current at $V_{DS} = 800 \text{ V}$ at $V_{DS} = 800 \text{ V}, T_C = 125^\circ\text{C}$ | I_{DSS} | - - | - - | 1 50 | μA |
| Gate Leakage Current at $V_{GS} = \pm 20 \text{ V}$ | I_{GSS} | - | - | ± 10 | μA |
| Gate-Source Threshold Voltage at $V_{DS} = V_{GS}, I_D = 100 \mu\text{A}$ | $V_{GS(\text{th})}$ | 3 | - | 5 | V |
| Drain-Source On-State Resistance at $V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$ | $R_{DS(\text{on})}$ | - | - | 0.26 | Ω |
| Diode Forward Voltage at $I_S = 19.5 \text{ A}, V_{GS} = 0 \text{ V}$ | V_{SD} | - | - | 1.5 | V |
| Maximum Body-Diode Continuous Current | I_S | - | - | 19.5 | A |
| Input Capacitance at $V_{GS} = 0 \text{ V}, V_{DS} = 100 \text{ V}, f = 1 \text{ MHz}$ | C_{iss} | - | 1600 | - | pF |
| Output Capacitance at $V_{GS} = 0 \text{ V}, V_{DS} = 100 \text{ V}, f = 1 \text{ MHz}$ | C_{oss} | - | 130 | - | pF |
| Reverse Transfer Capacitance at $V_{GS} = 0 \text{ V}, V_{DS} = 100 \text{ V}, f = 1 \text{ MHz}$ | C_{rss} | - | 2 | - | pF |
| Turn-On Delay Time at $I_D = 10 \text{ A}, V_{DD} = 400 \text{ V}, V_{GS} = 10 \text{ V}, R_G = 4.7 \Omega$ | $t_{d(on)}$ | - | 25 | - | ns |
| Turn-On Rise Time at $I_D = 10 \text{ A}, V_{DD} = 400 \text{ V}, V_{GS} = 10 \text{ V}, R_G = 4.7 \Omega$ | t_r | - | 13 | - | ns |
| Turn-Off Delay Time at $I_D = 10 \text{ A}, V_{DD} = 400 \text{ V}, V_{GS} = 10 \text{ V}, R_G = 4.7 \Omega$ | $t_{d(off)}$ | - | 60 | - | ns |
| Turn-Off Fall Time at $I_D = 10 \text{ A}, V_{DD} = 400 \text{ V}, V_{GS} = 10 \text{ V}, R_G = 4.7 \Omega$ | t_f | - | 15 | - | ns |

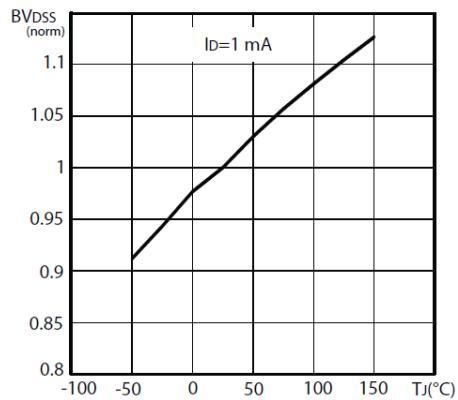


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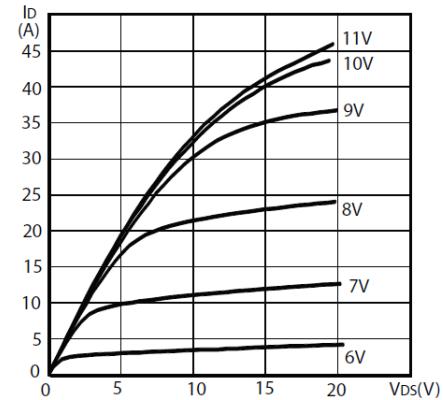


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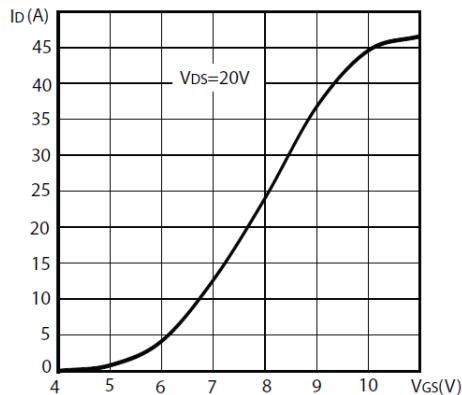
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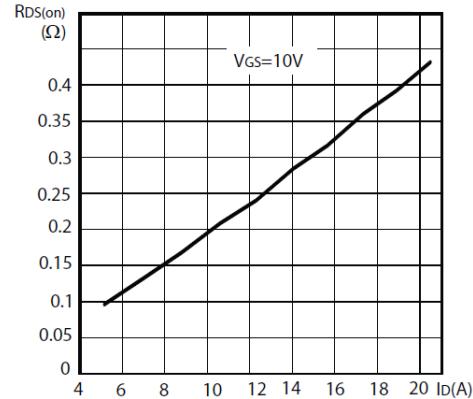
Normalized BV_{DSS} vs temperature



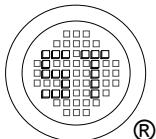
Output characteristics



Transfer characteristics



Static drain-source on-resistance



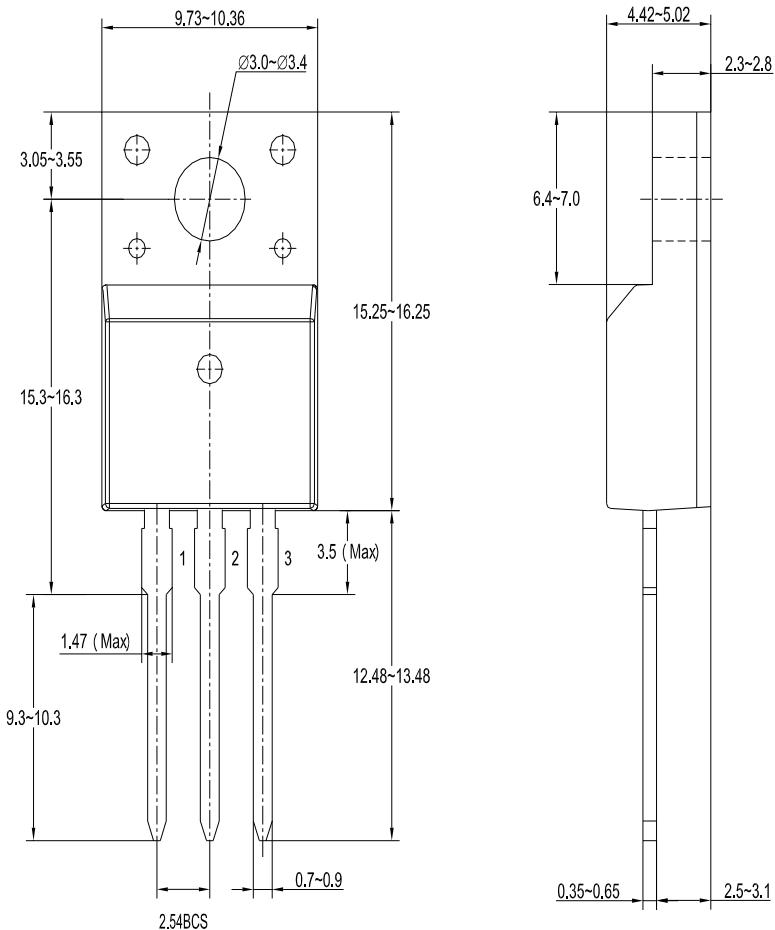
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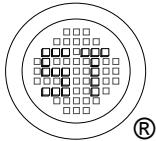
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TO-220F Package Outline



Dimensions in millimeters



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ISO9TS 16949 : 2009 ISO14001 : 2004 ISO 9001 : 2008 BS-OHSAS 18001 : 2007 IECQ QC 080000
Certificate No. 160713000 Certificate No. 7116 Certificate No. 60710410 Certificate No. 7116
BSI-UKAS
DEKRA
Intertek
UKAS
ISO 9001
ISO 14001
ISO 18001
IECQ QC 080000
SGS

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